ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V _{CC}) to GND+6V
Standby Supply Voltage (SV _{CC}) to GND+6V
REG, FB, REGON to GND0.3V to (V _{CC} + 0.3V)
BIAS, CBYPASS, MUTE, IN_, MICIN to GND0.3V to the
Larger of $(V_{CC} + 0.3V)$ or $(SV_{CC} + 0.3V)$
OUT_, MICOUT to GND0.3V to the Smaller
of $+5.5V$, or $(V_{CC} + 0.3V)$
Duration of Output Short-Circuit to GND or Vcc 10min

Continuous Power Dissipation	
10-Pin µMAX (derate 5.6mW/°C above +70°C)4	44mW
14-Pin SO (derate 8.3mW/°C above +70°C)66	67mW
20-Pin SO (derate 10.0mW/°C above +70°C)80	Wm0C
16-Pin TSSOP (derate 9.4mW/°C above +70°C)75	55mW
Operating Temperature Range40°C to -	+85°C
Storage Temperature Range65°C to +7	150°C
Lead Temperature (soldering, 10s)+	300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = SV_{CC} = +5V, R_L = \infty \text{ on all outputs, } C_{BYPASS} = 1\mu\text{F}, C_{BIAS} = 1\mu\text{F}, C_{REG} = 10\mu\text{F} \text{ (MAX4299)}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. } Load resistors (R_L) are terminated to 2.25V. Typical values are at <math>T_A = +25^{\circ}\text{C}$. Specifications apply to both MAX4298 and MAX4299, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Supply Voltage Range	Vcc	Inferred from PSRR test	4.5		5.5	V	
		MAX4298		10.2	17.5		
Quiescent Current	Icc	MAX4299		10.6	18.0	mA	
Mute Quiescent Current		MAX4298		10.2	17.5	то Л	
Mute Quiescent Current		MAX4299		10.6	18.0	mA	
CV Current (Note 2)	1	V _{BIAS} = 1.125V, V _{CC} = 0		300	500		
SV _{CC} Current (Note 2)	Isvcc	V _{BIAS} = 2.25V, V _{CC} = 5.0V		7		μΑ	
DRIVER AMPLIFIERS							
Input Offset Voltage	Vos			±1	±10	mV	
Input Bias Current	I _{BIAS}			0.2		nA	
		DC, V _{CC} = 4.5V to 5.5V		115			
Power-Supply Rejection Ratio	PSRR	f = 20kHz		93		dB	
Natio		f = 100kHz		80			
		$R_L = 10k\Omega$	1.45	1.59			
Output Drive	V _{OUT}	$R_L = 32\Omega$	1.2	1.53		V_{RMS}	
		$R_L = 16\Omega$	1.0	1.48			
		$A_V = -1V/V$, $f = 1kHz$, $R_L = 10k\Omega$, $V_{OUT} = 1.5V_{RMS}$		0.0008			
THD + Noise		$A_V = -1V/V, f = 1kHz, R_L = 32\Omega, \\ V_{OUT} = 1.2V_{RMS}, (Notes 3, 4)$		0.02	0.1	%	
		$A_V = -1V/V$, $f = 1kHz$, $R_L = 16\Omega$, $V_{OUT} = 1.0V_{RMS}$		0.04			
Full-Scale Signal-to-Noise Ratio (Note 4)	SNR	$R_L = 10k\Omega$, $V_{OUT} = 1.06V_{RMS}$, $A_V = -1V/V$		105		dB	
Capacitive Drive				22		nF	
Open-Loop Voltage Gain	Avol	$R_L = 32\Omega$, $0.55V \le V_{OUT} \le V_{CC} - 0.55V$	76	87		dB	
Unity-Gain Bandwidth	GBW			1.3		MHz	

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = SV_{CC} = +5V, R_L = \infty \text{ on all outputs, } C_{BYPASS} = 1\mu\text{F, } C_{BIAS} = 1\mu\text{F, } C_{REG} = 10\mu\text{F (MAX4299), } T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. } Load resistors (R_L) are terminated to 2.25V. Typical values are at <math>T_A = +25^{\circ}\text{C}$. Specifications apply to both MAX4298 and MAX4299, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS		
BIAS VOLTAGE OUTPUT	•						•		
DC BIAS Voltage	V _{BIAS}	I _L = 0		2.13	2.25	2.37	V		
Line Regulation					120		dB		
Load Regulation		$I_L = 0$ to $1\mu A$			50		mV		
DIGITAL INPUTS (MUTE for MA)	(4298/MAX42	99, and REG _{ON} for MAX	4299)						
Input Voltage High	V _{INH}			2.4			V		
Input Voltage Low	VINL					0.8	V		
Input Leakage Current	I _{IN}	VIN = 0 or VCC				±1	μΑ		
MICROPHONE AMPLIFIER (MA	X4299 only)								
Input Offset Voltage	Vos				±2	±10	mV		
Input Bias Current	IBIAS				0.2		nA		
		DC, $V_{CC} = 4.5V$ to 5.5V	1		115				
Power-Supply Rejection Ratio	PSRR	f = 20kHz		93		dB			
		f = 100kHz		80					
Voltage Gain	Avol	$R_L = 10k\Omega$, $0.13V \le V_{MI}$	COUT ≤ VCC - 0.13V	80	100		dB		
Output Drive	Vout	$R_L = 10k\Omega$		1.4	1.58		V _{RMS}		
THD + Noise (Note 4)	THD+N	$f = 1kHz$, $R_L = 10k\Omega$,	$A_V = -1V/V$		0.005	%			
THD + Noise (Note 4)	I I II D+N	VMICOUT = 1.5VRMS	$A_{V} = -10V/V$		0.03		70		
Full-Scale Signal-to-Noise Ratio (Note 4)	SNR	$R_L = 10k\Omega$, $V_{MICOUT} = 1$	1.06V _{RMS} , A _V = -10V/V		80		dB		
All-Hostile Crosstalk		f = 10kHz (Note 5)			80		dB		
Unity Gain Bandwidth	GBW				1		MHz		
REGULATOR (MAX4299 only)	•						•		
Regulator Output Voltage	V _{REG}	V _{CC} = 4.5V to 5.5V. I _L = 0 to 100mA, using internal feedback		3.15	3.3	3.45	V		
Line Regulation		$V_{CC} = 4.5V \text{ to } 5.5V, I_L = 0.000$	= 50mA		0.2		mV		
Load Degulation		I _L = 10mA to 100mA		I _L = 10mA to 100mA			30		mV
Load Regulation		I _L = 0 to 100mA			50		mV		
FB Voltage	V _{FB}	Reference for regulator	adjustment		1.233		V		

Note 1: All devices are 100% production tested at T_A = +25°C. All temperature limits are guaranteed by design.

Note 2: Current drawn from SV_{CC} when $V_{CC} < 4V$.

Note 3: Guaranteed by design.

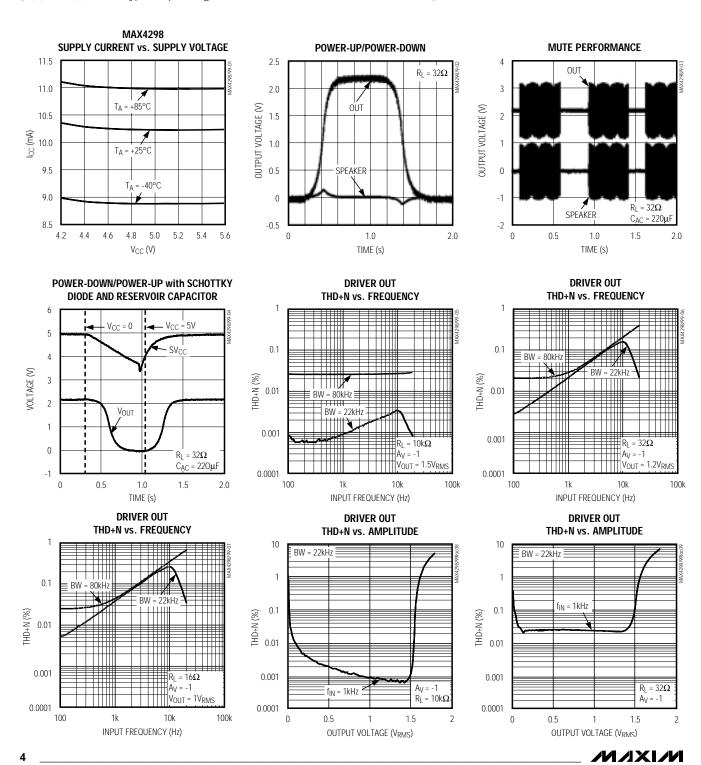
Note 4: Measurement bandwidth is 20Hz to 22kHz.

Note 5: Voltage at MICOUT with OUT1 = OUT2 = $1V_{RMS}$ into 32Ω .



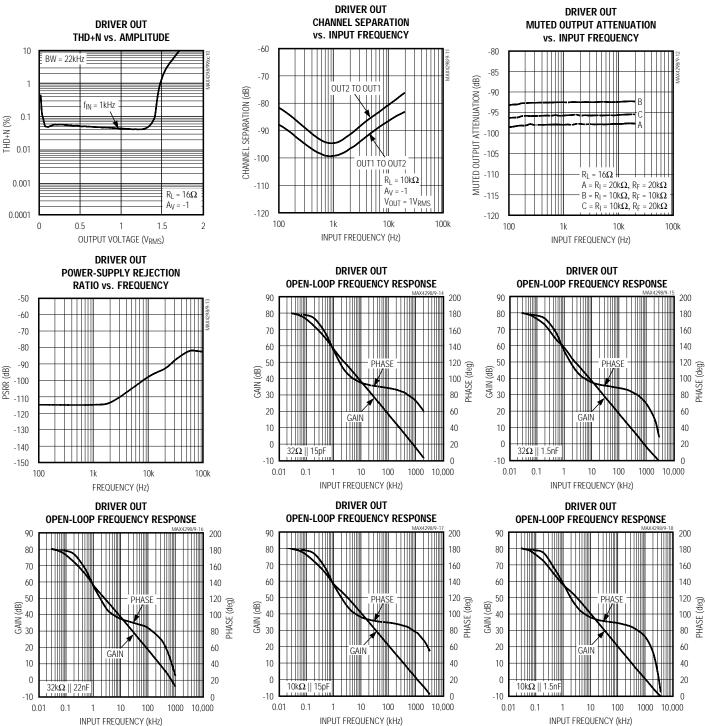
Typical Operating Characteristics

(V_{CC} = SV_{CC} = +5V, typical operating circuit, T_A = +25°C, unless otherwise noted.)



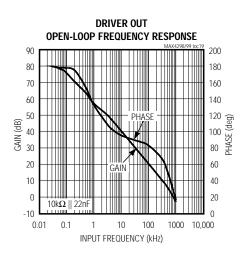
Typical Operating Characteristics (continued)

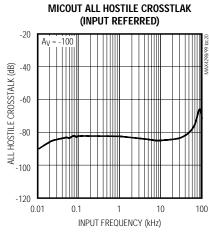
 $(V_{CC} = SV_{CC} = +5V, \text{ typical operating circuit, } T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

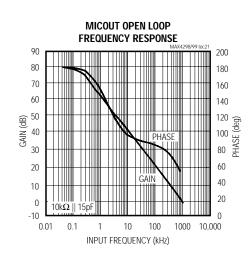


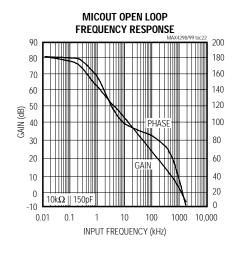
Typical Operating Characteristics (continued)

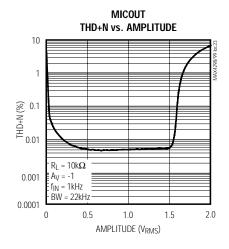
 $(V_{CC} = SV_{CC} = +5V, typical operating circuit, T_A = +25°C, unless otherwise noted.)$

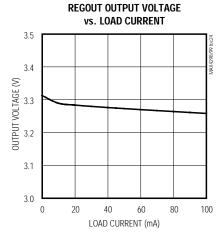


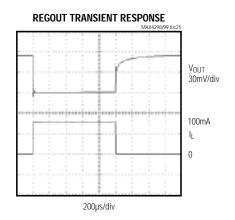


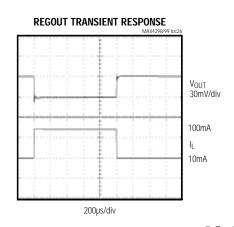












Pin Description

	P	IN			
MAX4298	MAX4298	MAX4299	MAX4299	NAME	FUNCTION
10-PIN μ MAX	14-PIN SO	16-PIN TSSOP	20-PIN SO	NAME	FUNCTION
_	_	16	1	REG	Regulator Output. Bypass REG to GND with a $10\mu\text{F}$ capacitor.
_	_	1	2	FB	Regulator Feedback. Internal resistors from this point to REG and GND define the regulator output value. Adjustments can be made to the output value by adding resistors in the same place externally.
1	2	2	4	OUT1	Driver Amplifier Output
_	_	3	5	PGND	Power Ground for Driver Outputs
2	3	4	6	GND	Ground
3	4	5	7	IN1	Inverting Input for Driver Amplifier
4	5	6	8	BIAS	Bias Point for Amplifiers. Bypass BIAS to GND with a $1\mu\text{F}$ capacitor.
5	6	7	9	SV _{CC}	Standby Power Supply. Connect to a standby +5V supply that is always on, or bypass with $220\mu F$ and connect a Schottky diode from V _{CC} to SV _{CC} . Short to V _{CC} if clickless power-down is not essential.
_	_	8	10	MICOUT	Microphone Amplifier Output
_	_	9	11	MICIN	Inverting Input for Microphone Amplifier
6	9	10	13	MUTE	Mute Digital Input. Connect to GND for normal operation. When MUTE is connected to V _{CC} , OUT1 and OUT2 are muted, REG stays on, and MICOUT stays on.
7	10	11	14	CBYPASS	Bypass to GND with a 1µF Capacitor
8	11	12	15	IN2	Inverting Input for Driver Amplifier
9	12	13	16	OUT2	Driver Amplifier Output
10	13	14	17	V _C C	Power Supply. Connect to +5V.
_	1, 7, 8, 14	_	3, 12, 18, 19	N.C.	No Connection. Not internally connected.
_	_	15	20	REGON	Regulator Control. Connect to V _{CC} for normal operation. Connect to GND to shut off the regulator.

Detailed Description

The MAX4298/MAX4299 are audio system ICs designed for single +5V applications. The MAX4299 has a stereo headphone driver, a microphone amplifier, and a 100mA +3.3V linear regulator; the MAX4298 has the stereo headphone driver only. The MAX4298/MAX4299 are designed specifically for harsh digital environments where board space is at a premium and the digital

power supply is noisy. The design uses innovative design techniques to achieve ultra-high power-supply rejection across the audio signal band while, at the same time, delivering a high current rail-to-rail output drive capability. These devices are designed to drive highly capacitive loads that may be encountered when driving long cables to a remote load such as desktop/notebook headphones or speakers. They are fully compliant to PC99 standards. Figure 1 is the



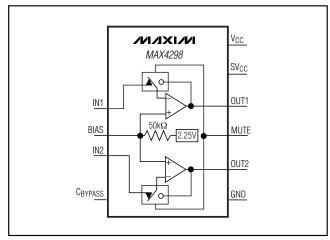


Figure 1. MAX4298 Block Diagram

The amplifiers exhibit better than 115dB of DC power-supply rejection and 93dB at 20kHz. The output amplifiers are capable of driving a 1.5VRMs signal into $10k\Omega$ load with 0.0008% distortion. They can also drive 32Ω headphones to 1.2VRMs with 0.02% distortion. At +3.3V, the linear regulator can output 100mA of current.

BIAS

The common-mode bias point for the amplifiers is set to 2.25V by internal circuitry that has two functions. It provides a clickless/popless power-up/power-down waveform for the amplifiers. Also, it generates a ground-referenced bias voltage with ultra-high power-supply rejection ratio (PSRR). BIAS should be bypassed with $1\mu\mathrm{F}$ to GND.The output impedance of the BIAS pin is $50\mathrm{k}\Omega$.

Clickless/Popless Function

The MAX4298/MAX4299 are designed for high-fidelity audio performance into AC-coupled loads. The design techniques achieve a clickless/popless power-up sequence, and the use of a low-current standby supply (SV_{CC}) or external Schottky diode/reservoir capacitor combination allows clickless/popless power-down. A clickless/popless mute function is also provided to maintain a low impedance output when the input signal is switched off.

Mute Function

The MAX4298/MAX4299 have a MUTE pin that allows the user to mute the outputs of the device. This feature disconnects the input signal from the power amplifiers when a logic high is present at the MUTE pin. To ensure proper functionality, the MUTE pin should always be tied to either VCC or GND. MUTE only affects the headphone driver outputs. REG, BIAS, and MICOUT are unaffected. OUT1 and OUT2 are muted, but remain in a low-impedance state to ensure clickless/popless operation.

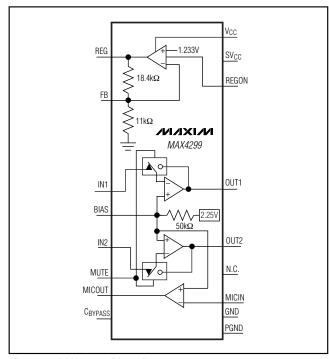


Figure 2. MAX4299 Block Diagram

SVCC

The MAX4298/MAX4299 provide a fully clickless power-down sequence. SVCC normally should be connected to a low-current +5V power source, but alternatively can be connected with a reservoir capacitor to ground and a Schottky diode to VCC. A reservoir capacitor of 220µF or higher provides enough charge for the clickless power-down sequence when CBIAS = 1µF. For larger values of CBIAS, increase the reservoir capacitor accordingly. Short to VCC if clickless power-down is not needed.

Driver Amplifier

The headphone driver amplifier is a class AB amplifier designed to drive 16 Ω loads. The amplifiers have innovative architectures for both the input and output stages to achieve ultra-high PSRR while maintaining rail-to-rail output drive capability. The output stage can drive high capacitive loads encountered when driving long cables used for desktop speakers or headphones.

Microphone Preamplifier (MAX4299)

The MAX4299 provides a microphone preamplifier that is a low-power version of the audio amplifier. It is intended to be used for low-level signal amplification. This microphone preamplifier provides rail-to-rail output with very high PSRR.

Regulator (MAX4299)

The MAX4299 also has an additional 100mA low-dropout (LDO) regulator to provide clean analog power for other sensitive analog circuitry on the PC board, such as a typical PC99 audio codec or microphone biasing. It is designed to provide good AC line regulation. The nominal output voltage of REG is 3.3V, and is adjustable between 1.2V and 4.5V by connecting a resistor-divider from REG to GND. Connect FB to the junction of the resistor-divider. The input impedance at FB is typically $7k\Omega_{\rm r}$, which should be considered in output voltage calculations. REG should be bypassed to GND with at least $10\mu F$.

Applications Information

Capacitor Selection and Regulator Stability

Normally, use a 10µF capacitor on REG (MAX4299 only) and a 1µF capacitor on CBYPASS. Larger capacitor values and lower ESRs provide better supply-noise rejection and line-transient response. Reduce noise and improve load-transient response, stability, and power-supply rejection by using larger capacitors. For stable operation over the full temperature range and load currents up to 100mA, a minimum of 10µF (REG) and 1µF (CBYPASS) is recommended.

Use a 1µF bypass capacitor on BIAS to ensure a fully clickless/popless power-up sequence. Smaller capacitor values may be used here to decrease the power-up time, but may cause the power-up transient to become audible. Larger bypass capacitors are not necessary to reduce noise and/or improve AC power-supply rejection.

SVCC is the standby power supply. If using an external diode for charging, a 220 μ F reservoir capacitor on SVCC provides standby power for the clickless power-down sequence. Smaller capacitors here may cause an audible output transient on power-down; 220 μ F or higher provides enough energy when CBIAS = 1 μ F. For larger values of CBIAS, increase the reservoir capacitor accordingly.

Mic Biasing (MAX4299)

Common microphone elements require resistive biasing to power their internal circuitry. A $2k\Omega$ resistor is typically used, and the microphone is AC-coupled to the microphone amplifier. If the microphone element allows low-voltage operation, biasing to the REG output provides excellent power-supply rejection.

Power Supply and Bypassing

The excellent PSRR of the MAX4298/MAX4299 allows them to operate from noisy power supplies. In most applications, a $0.1\mu F$ capacitor from V_{CC} to GND is sufficient. This bypass capacitor should be placed close to the V_{CC} pin.

Layout

Good layout improves performance by decreasing the amount of stray capacitance and noise at the power amplifier's inputs and output. To decrease stray capacitance, minimize PC board trace lengths and resistor leads, and place external components as close to the pins as possible.

Power Dissipation

The first equation below indicates the maximum power dissipation point for a package that has two power amplifiers operating at identical known supply voltages and loads with sine wave inputs:

$$PIC(DISS) = (VCC)^2 / (\pi^2 RL) [W]$$

For example, with a 5V power supply and a load of 16Ω , the maximum power dissipation of the amplifiers alone is 317mW.

The additional power dissipation due to the 100mA regulator operating at maximum current is nominally 170mW, but will increase if the output is reduced externally from its nominal 3.3V. The regulator power consumption is given by:

$$PREG = (VCC - VREG) \times 100mA [W]$$

To avoid thermal shutdown the sum of the regulator and amplifier power dissipation must not exceed the absolute maximum power-dissipation rating of the package.

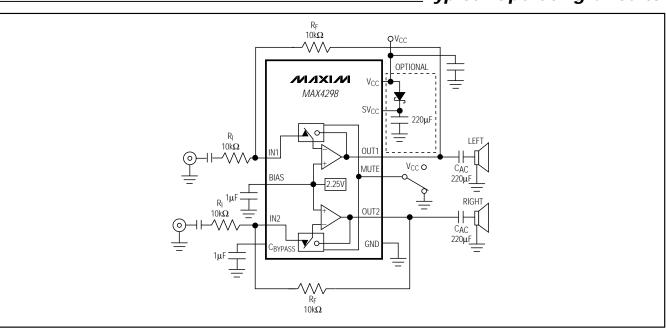
Short-Circuit Protection and Thermal Shutdown

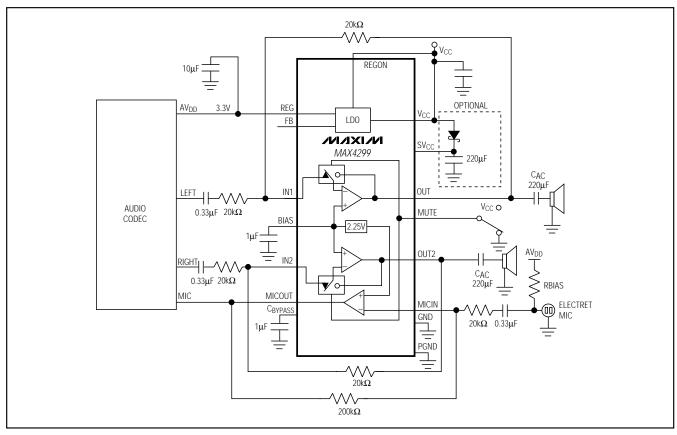
The MAX4298/MAX4299 have short-circuit current protection on all outputs. They also have a thermal shutdown function designed to protect the chip from junction temperatures in excess of +150°C that may arise from temporary short circuits or operation beyond the power dissipation limit of the package. The driver amplifier outputs limit at around ±220mA, the regulator at 150mA, and the microphone amplifier at +1.5mA/-12mA.

USB Applications

Universal serial bus (USB) interfaces are an increasingly popular method of interfacing medium-speed (up to 12Mbps) PC peripherals. One of the great benefits of the USB interface is the inclusion of a +5V supply. While this supply works well for a mouse or keyboard, its susceptibility for noise pickup can be unsuitable for highfidelity audio applications. The MAX4298/MAX4299s' excellent PSRR make them ideal candidates for USB applications due to their insensitivity to the supply noise. Of particular interest is an Internet-Protocol (IP) phone. This PC peripheral uses the local internet service provider as a free long-distance phone. The MAX4299, with its integral microphone amp, headphone driver, and linear regulator, can be a key element in the implementation of an IP phone that interfaces to the PC through the USB.

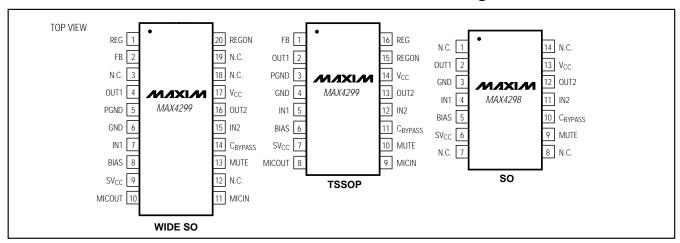
Typical Operating Circuits





10 _______/**W**/**X**/**W**

Pin Configurations (continued)

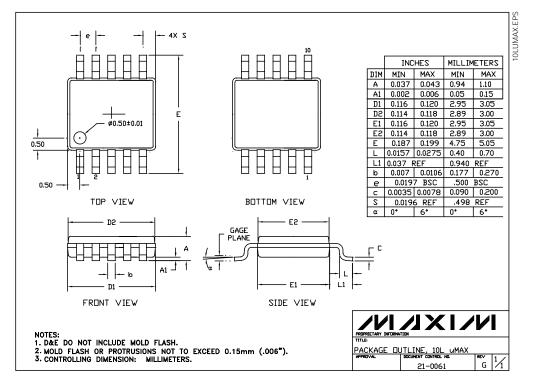


Chip Information

MAX4298 TRANSISTOR COUNT: 760 MAX4299 TRANSISTOR COUNT: 905

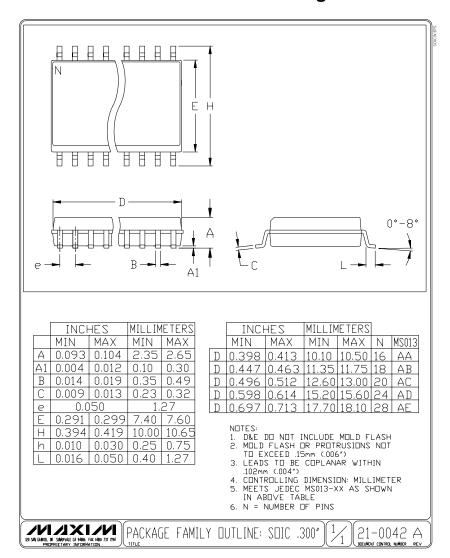
PROCESS: BICMOS

Package Information



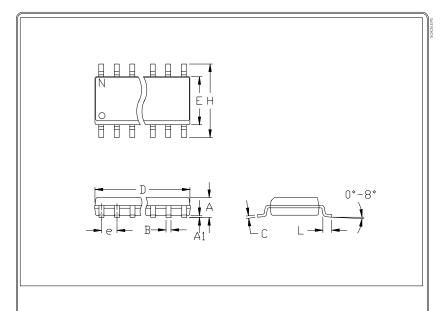
MIXIM

Package Information (continued)



MIXIN

Package Information (continued)



			L			
	INC	HES	MILLIMETERS			
	MIN	MAX	MIN	MAX		
Α	0.053	0.069	1.35	1.75		
Α1	0.004	0.010	0.10	0.25		
В	0.014	0.019	0.35	0.49		
С	0.007	0.010	0.19	0.25		
е	0.0	50	1.27			
E	0.150	0.157	3.80	4.00		
Н	0.228	0.244	5.80	6.20		
h	0.010	0.020	0.25	0.50		
L	0.016	0.050	0.40	1.27		

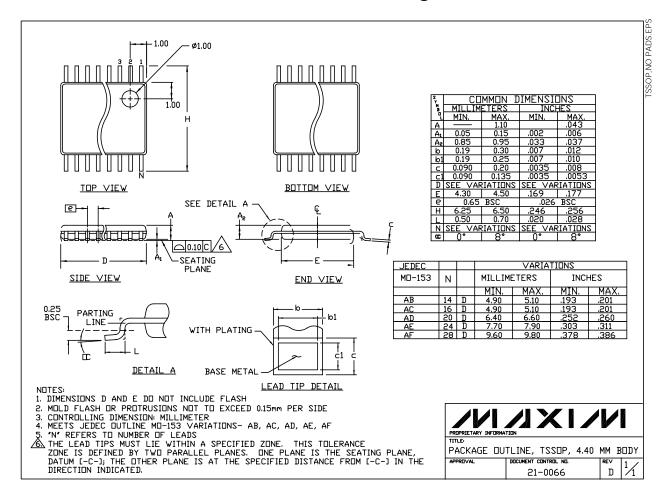
	INC	HES	MILLIM			
	MIN	MAX	MIN	MAX	Ν	MS012
D	0.189	0.197	4.80	5.00	8	Α
D	0.337	0.344	8.55		14	В
D	0.386	0.394	9.80	10.00	16	С

- NOTES:
 1. D&E DO NOT INCLUDE MOLD FLASH
 2. MOLD FLASH DR PROTRUSIONS NOT
 TO EXCEED .15mm (.006*)
 3. LEADS TO BE COPLANAR WITHIN
 .102mm (.004*)
 4. CONTROLLING DIMENSION: MILLIMETER
 5. MEETS JEDEC MS012-XX AS SHOWN
 IN ABOVE TABLE
 6. N = NUMBER OF PINS





Package Information (continued)



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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